TIDA-00384

DLP Board
#2513854

Main Board
#2513848

Optical Engine
LED connection
DMD connection

DLPA2005
DLPC3438

VLED (R/G/B)
BIAS, RST, OFS
RESETZ
SPI
SPI
1.1V
1.8V
SYSPWR
PROJ_ON
1.1V
1.8V
24 Bit Data
CTRL
Parallel I/F
24 Bit Data
CTRL

ITT6801

USB-SPI Bridge
PROJ_ON
I2C

CY7C65215

1.2
USB

MSP430

5V DV

Push Buttons

DAC
TLV320DAC3101

4DMI
Audio Out

12C

EE PROM

Parallel I/F
24 Bit Data
CTRL

DMD connection

TIDA-00384
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